

#### **Description**

The E250N50X4 is high performance Aluminum Nitride (AIN) termination intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators and for use in power combiners. The termination is also RoHS compliant!

## **General Specifications**

Resistive Element Thick film
Substrate AIN Ceramic

Terminal Finish Matte Tin over Nickel Barrier

Operating Temperature -50 to +200°C (see de rating chart)

Tolerance is  $\pm 0.010$ ", unless otherwise specified. $\pm \pm$  Designed to meet of exceed applicable portions of MIL-E-5400. **All dimensions in inches.** 

# **Electrical Specifications**

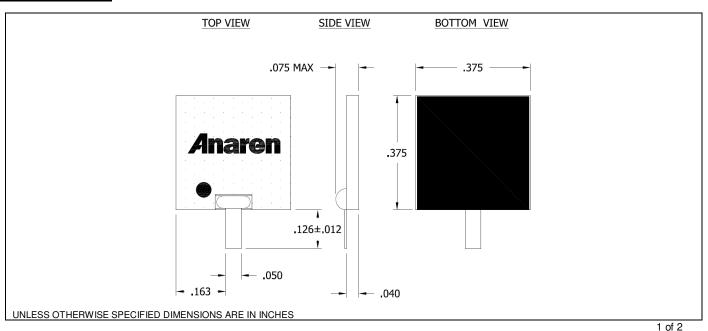
Resistance Value:50 Ohms,  $\pm$  2%Power:250 WattsFrequency Range:DC - 2.2 GHzReturn Loss> 20 dB DC - 2.2 GHz

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.** 

### Features:

- RoHS Compliant
- 250 Watts
- DC 2.2GHz
- AIN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

### **Outline Drawing**

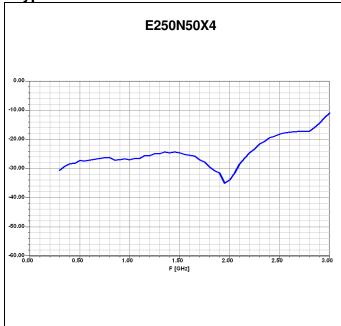


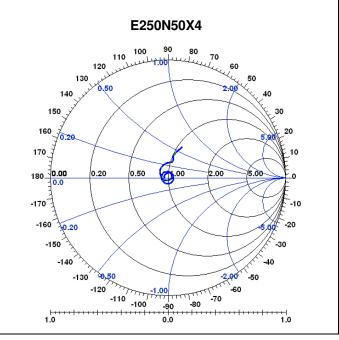


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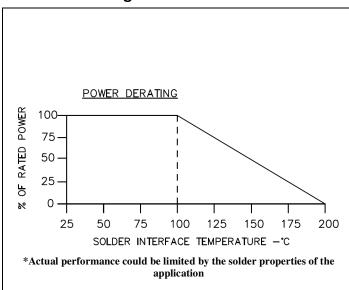


**Typical Performance:** 

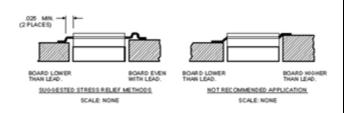




### **Power De-rating:**



# **Mounting Footprint and Procedure:**



#### SUGGESTED MOUNTING PROCEDURE

- MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
- POSITION DEVICE ON MOUNTING SURFACE AND SOLDER IN PLACE USING AN APPROPRIATE SOLDER.
- SOLDER LEADS IN PLACE USING AN APPROPRIATE SOLDER TYPE WITH A CONTROLLED TEMPERATURE IRON.

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